

**Absolute Maximum Ratings** (Voltage relative to GND, @ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Input Voltage	$V_{IN}$	-0.3 to 100	V
Continuous Input & Output Current	$I_{IN}, I_{OUT}$	400	mA
Peak Pulsed Input & Output Current	$I_{IM}, I_{OM}$	2	A
Maximum Voltage applied to $V_{OUT}$	$V_{OUT(MAX)}$	Smaller of $V_{IN}+8.2\text{V}$ or 14.5V	V

**Maximum Current at  $V_{IN} = 48\text{V}$**  (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Continuous Output Current	(Note 7)	$I_{OUT}$	42	mA
Pulsed Output Current	(Note 8)	$I_{OM}$	800	mA
	(Note 9)		160	

**Thermal Characteristics**

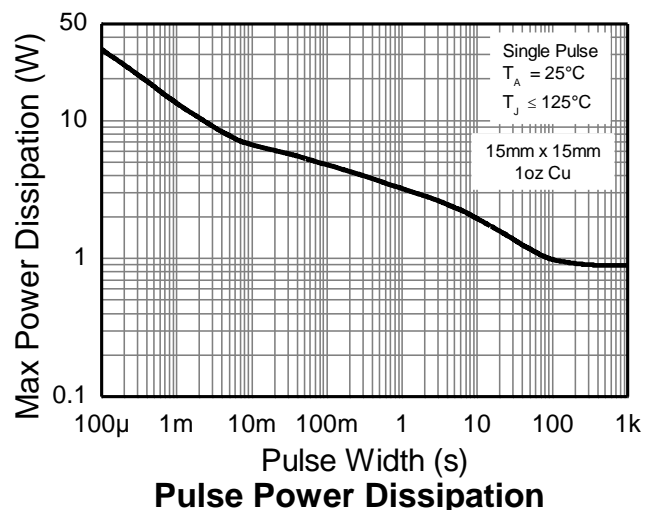
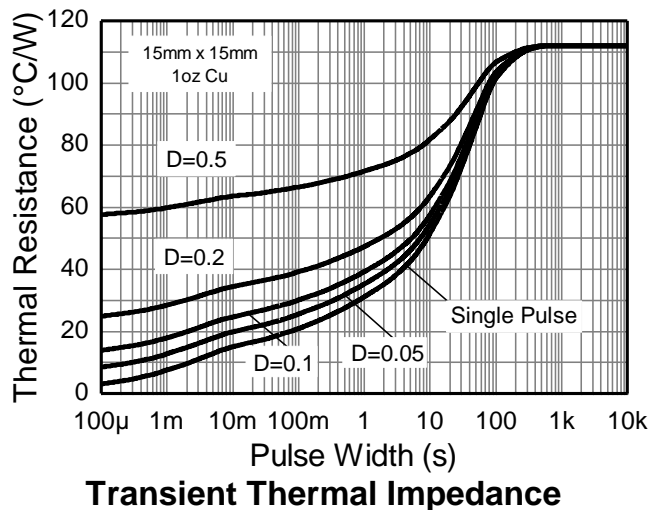
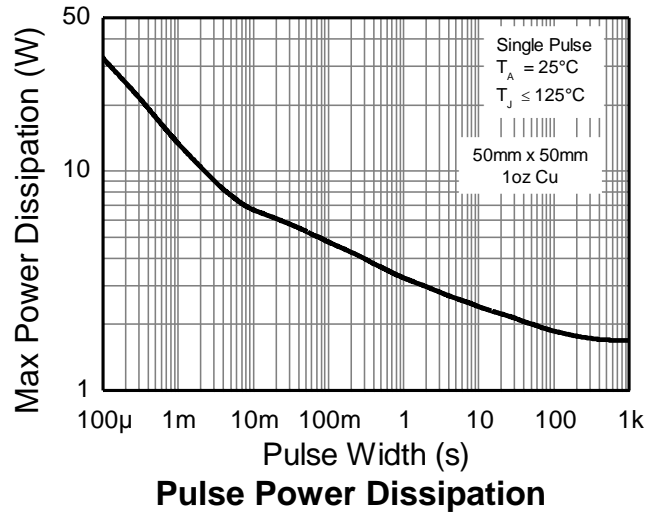
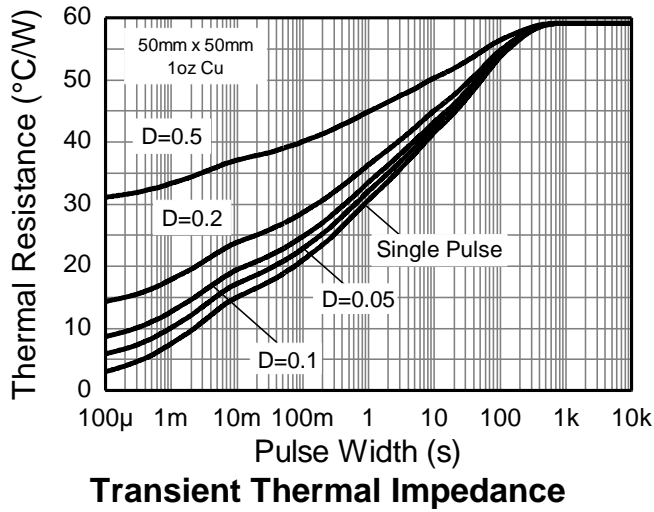
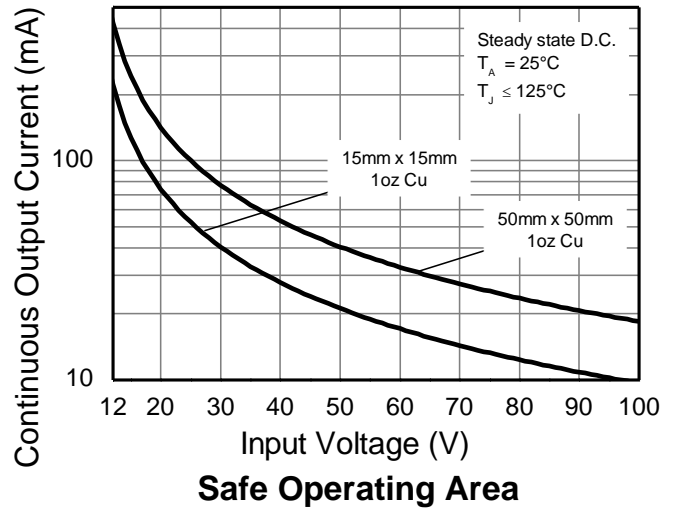
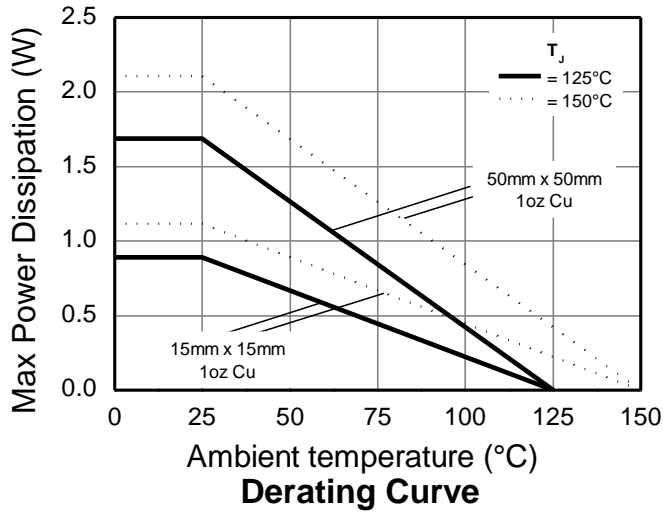
Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 5)	$P_D$	1.7	W
	(Note 6)		0.89	
Thermal Resistance, Junction to Ambient	(Note 5)	$R_{\theta JA}$	59	$^\circ\text{C/W}$
	(Note 6)		112	
Thermal Resistance, Junction to Lead	(Note 10)	$R_{\theta JL}$	20	
Thermal Resistance, Junction to Case	(Note 10)	$R_{\theta JC}$	15.7	
Recommended Operating Junction Temperature Range		$T_J$	-40 to +125	
Maximum Operating Junction and Storage Temperature Range		$T_J, T_{STG}$	-65 to +150	$^\circ\text{C}$

**ESD Ratings** (Note 11)

Characteristics	Symbols	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	C

- Notes:
- For a device mounted with the exposed  $V_{IN}$  pad on 50mm x 50mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
  - Same as Note 5, except mounted on 15mm x 15mm 1oz copper.
  - Same as Note 5, whilst operating at  $V_{IN} = 48\text{V}$ . Refer to Safe Operating Area for other Input Voltages.
  - Same as Note 5, except measured with a single pulse width = 100 $\mu\text{s}$  and  $V_{IN} = 48\text{V}$ .
  - Same as Note 5, except measured with a single pulse width = 10ms and  $V_{IN} = 48\text{V}$ .
  - $R_{\theta JL}$  = Thermal resistance from junction to solder-point (on the exposed  $V_{IN}$  pad).  $R_{\theta JC}$  = Thermal resistance from junction to the top of case.
  - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

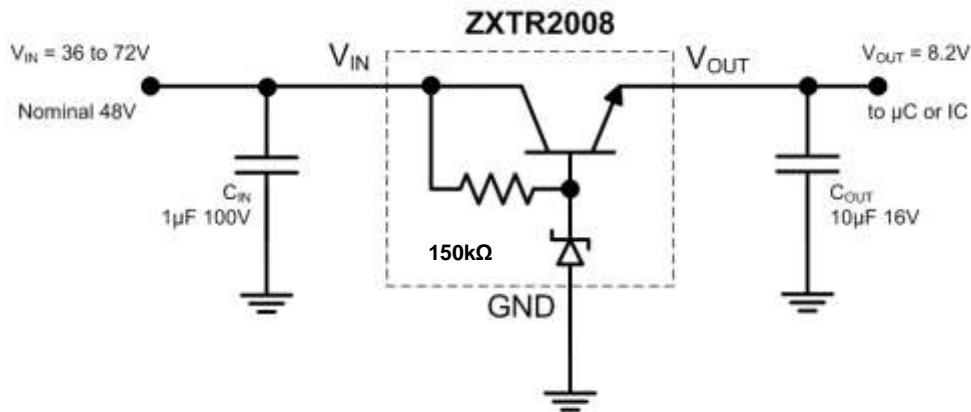
**Thermal Characteristics and Derating Information**



**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Output Voltage (Note 12)	V <sub>OUT</sub>	7.38	8.2	9.02	V	V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 15mA
Line Regulation (Notes 12 & 13)	ΔV <sub>OUT</sub>	—	10	300	mV	V <sub>IN</sub> = 12 to 100V, I <sub>OUT</sub> = 15mA
Temperature Coefficient	ΔV <sub>OUT</sub> /ΔT	—	10	—	mV/°C	T <sub>J</sub> = -40°C to +125°C V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 15mA
Load Regulation (Notes 12 & 14)	ΔV <sub>OUT</sub>	—	-180 -250	-350 -500	mV	I <sub>OUT</sub> = 0.1 to 30mA, V <sub>IN</sub> = 48V I <sub>OUT</sub> = 0.1 to 100mA, V <sub>IN</sub> = 48V
Minimum Value of Input Voltage Required to Maintain Line Regulation	V <sub>IN(MIN)</sub>	12	—	—	V	—
Quiescent Current	I <sub>Q</sub>	—	275 650	500 900	μA	V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 10μA V <sub>IN</sub> = 100V, I <sub>OUT</sub> = 10μA
Power Supply Rejection Ratio	ΔV <sub>IN</sub> /ΔV <sub>OUT</sub>	—	38	—	dB	C <sub>OUT</sub> = 100nF, I <sub>OUT</sub> = 15mA, V <sub>OUT</sub> = 8.2V, V <sub>IN</sub> = 12 to 100V, f = 100Hz

- Notes:
- 12. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%
  - 13. Line regulation  $\Delta V_{OUT} = V_{OUT}(@ V_{IN} = 100V) - V_{OUT}(@ V_{IN} = 12V)$
  - 14. Load regulation  $\Delta V_{OUT} = V_{OUT}(@ I_{OUT} = 30mA) - V_{OUT}(@ I_{OUT} = 0.1mA)$   
 $\Delta V_{OUT} = V_{OUT}(@ I_{OUT} = 100mA) - V_{OUT}(@ I_{OUT} = 0.1mA)$

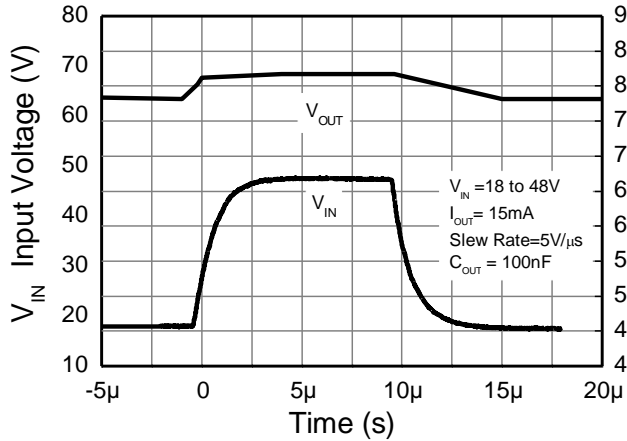
**Typical Application Circuit**


Example of an 8.2V regulated supply from a nominal 48V for powering a Controller IC.

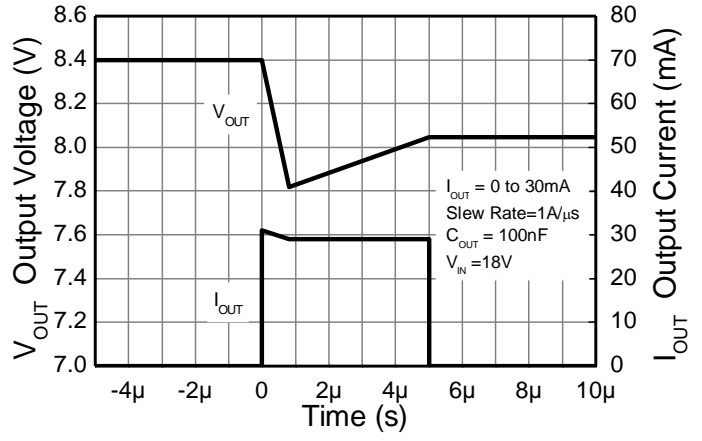
**Pin Functions**

Pin Name	Pin Function	Notes
V <sub>IN</sub>	Input Supply	Input voltage can vary from -0.3V to 100V with respect to GND; for V <sub>OUT</sub> regulated then 12V ≤ V <sub>IN</sub> ≤ 100V. It is recommended to connect a 1μF capacitor to GND.
GND	Power Ground	This pin should be tied to the system ground.
V <sub>OUT</sub>	Voltage Output	Outputs a regulated 8V when 12V ≤ V <sub>IN</sub> ≤ 100V. When V <sub>IN</sub> < 12V, then V <sub>OUT</sub> maximum = V <sub>IN</sub> - 1.5V. The pin can be pulled high to a maximum of +14V with respect to GND, or +8V with respect to V <sub>IN</sub> , whichever is lower. It is recommended to connect a 10μF capacitor to GND and a minimum of 10μA to be drawn from V <sub>OUT</sub> to maintain regulation.

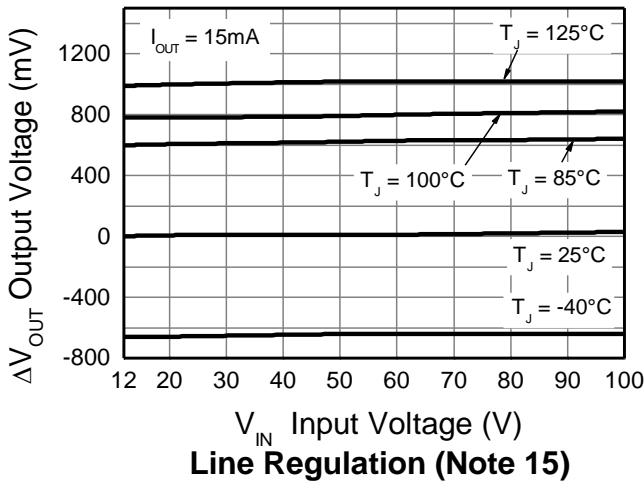
**Typical Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)



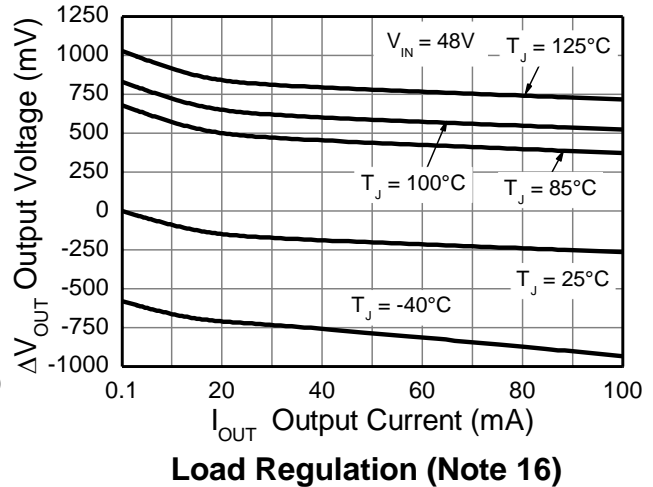
**Line transient response**



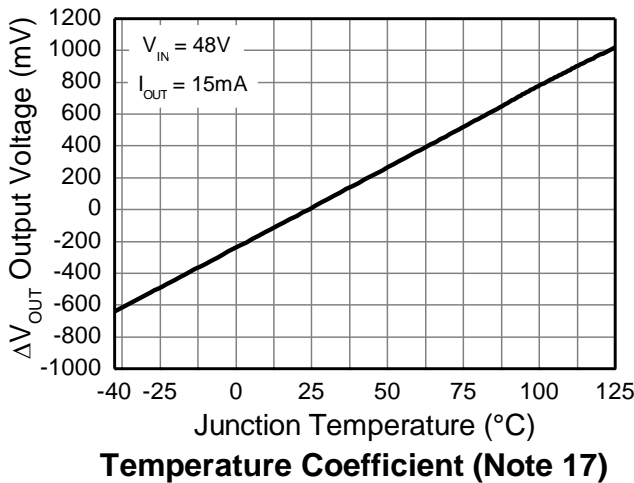
**Load transient response**



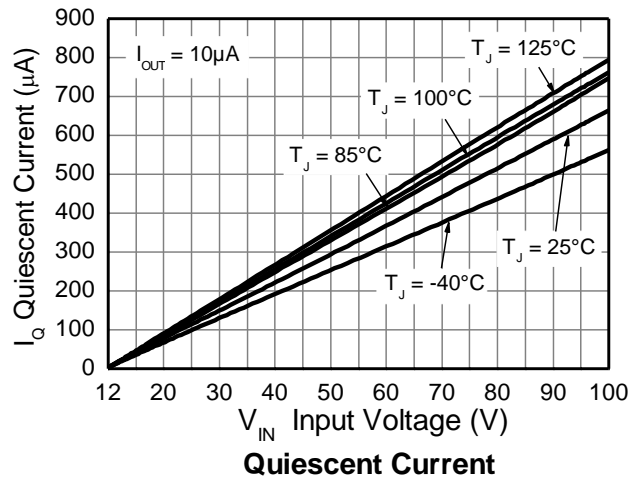
**Line Regulation (Note 15)**



**Load Regulation (Note 16)**



**Temperature Coefficient (Note 17)**

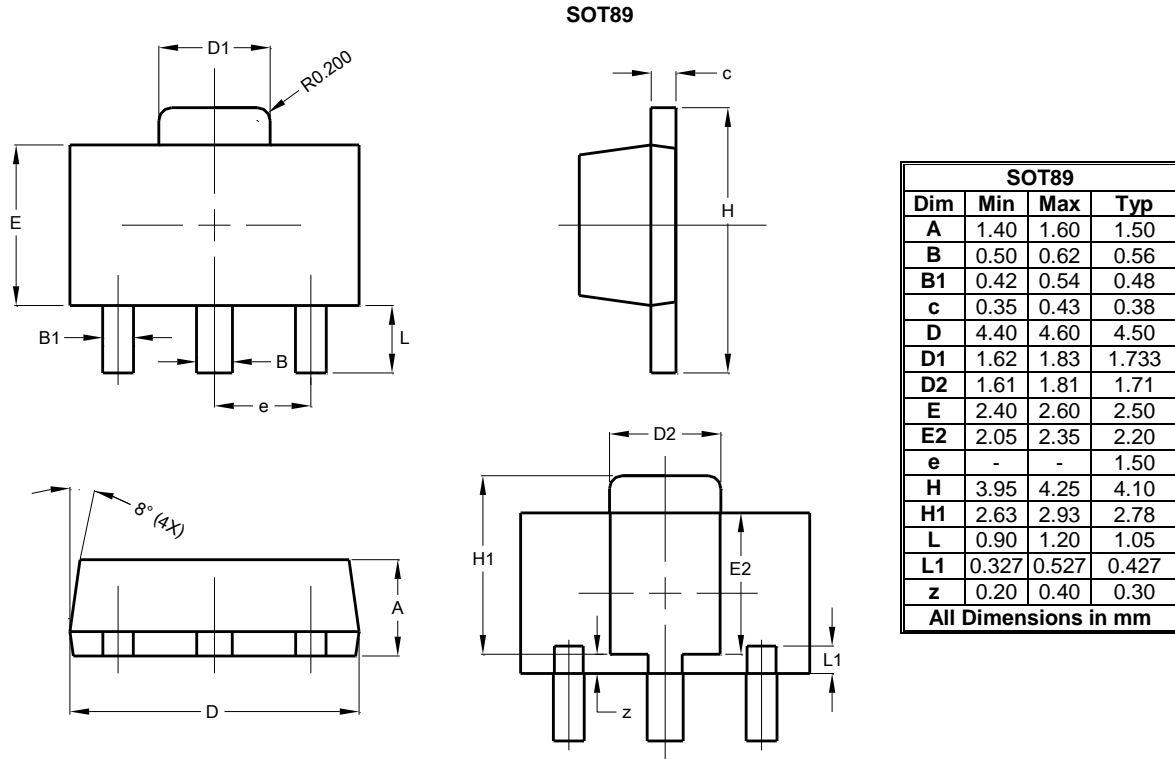


**Quiescent Current**

- Notes:
- 15. Line regulation  $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@ V_{IN} = 12\text{V}, I_{OUT} = 15\text{mA}, T_J = +25^\circ\text{C})$
  - 16. Load regulation  $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@ V_{IN} = 48\text{V}, I_{OUT} = 0.1\text{mA}, T_J = +25^\circ\text{C})$
  - 17. Temperature Coefficient  $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@ V_{IN} = 48\text{V}, I_{OUT} = 15\text{mA}, T_J = +25^\circ\text{C})$

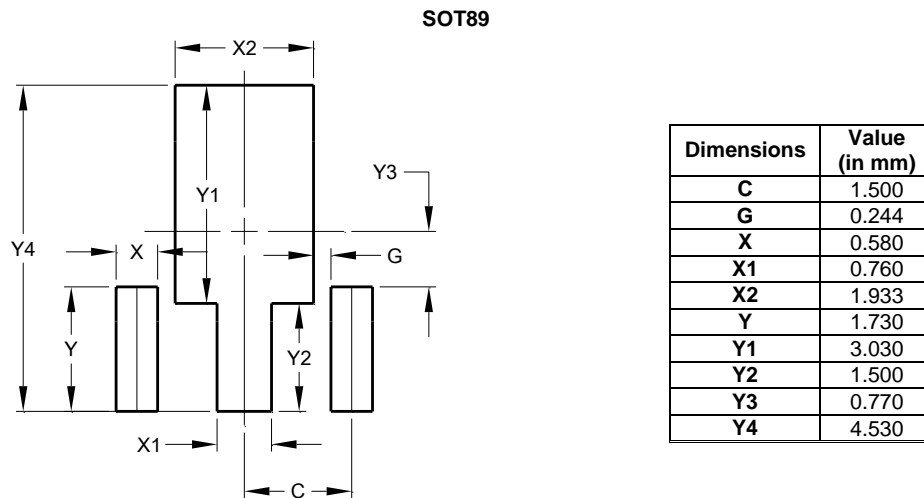
## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



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